

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S59	2907	((conductive or electroconductive) near3 (paste or composition or compound)) and (((multilayer\$2 or (multi near layer\$2)) near ceramic))	US-PGPUB; USPAT; EPO; JPO; DERWENT	AND	ON	2008/08/19 15:19
S60	4494	(metal or silver or Ag or gold or Au or copper or cu or ni or nickel or al or aluminum) near2 (coat\$2 or dop\$2) near2 (alumina or zirconia or oxide?)	US-PGPUB; USPAT; EPO; JPO; DERWENT	AND	ON	2008/08/19 15:22
S61	27	S59 S60	US-PGPUB; USPAT; EPO; JPO; DERWENT	AND	ON	2008/08/19 15:22
S62	723	(metal or silver or Ag or gold or Au or copper or cu or ni or nickel or al or aluminum) near2 (coat\$2 or dop\$2 or (surface)) near2 (alumina or zirconia or oxide?) near2 (particle or powder or particulate)	US-PGPUB; USPAT; EPO; JPO; DERWENT	AND	ON	2008/08/19 15:24
S63	14	S59 S62	US-PGPUB; USPAT; EPO; JPO; DERWENT	AND	ON	2008/08/19 15:25
S64	2	("4594181").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/08/19 15:30
S65	6	((("4547625") or ("4301324")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	OFF	2008/08/19 17:33
S66	1474	((conductive or electroconductive or connect\$4) near (paste or composition or formulation)) and ((glass or frit) same ((soften\$3 or melt\$3) near (temperature or temp or point)) and (copper or Cu))	US-PGPUB; USPAT; EPO; JPO; DERWENT	AND	ON	2008/08/19 20:17

S67	989	((conductive or electroconductive or connect\$4) near (paste or composition or formulation)) and ((glass or frit) with ((soften\$3 or melt\$3) near point) and (copper or Cu))	US-PGPUB; USPAT; EPO; JPO; DERWENT	AND	ON	2008/08/19 20:18
S68	138	((conductive or electroconductive or connect\$4) near (paste or composition or formulation)) same ((glass or frit) with ((soften\$3 or melt\$3) near point) and (copper or Cu))	US-PGPUB; USPAT; EPO; JPO; DERWENT	AND	ON	2008/08/19 20:18
S69	79	((conductive or electroconductive or connect\$4) near (paste or composition or formulation)) same ((glass or frit) with ((soften\$3 or melt\$3) near point) same (copper or Cu))	US-PGPUB; USPAT; EPO; JPO; DERWENT	AND	ON	2008/08/19 20:18
S70	20	S69 and (((multilayer\$2 or (multi near layer\$2)) near ceramic))	US-PGPUB; USPAT; EPO; JPO; DERWENT	AND	ON	2008/08/19 20:19
S71	43	((conductive or electroconductive or connect\$4) near (paste or composition or formulation)) same ((glass or frit) with (soften\$3 near point) same (copper or Cu))	US-PGPUB; USPAT; EPO; JPO; DERWENT	AND	ON	2008/08/19 20:30

8/20/2008 1:11:14 PM

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